

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : Wen-Ching Chen :  
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Patent No. : 6,828,543 : Mail Stop PGPUB  
Issued : 7 December 2004  
Title : FLIP CHIP PACKAGE STRUCTURE FOR AN  
IMAGE SENSOR AND AN IMAGE SENSE  
MODULE WITH THE FLIP CHIP PACKAGE  
STRUCTURE

REQUEST FOR PUBLICATION FEE REFUND

Mail Stop PGPUB  
Commissioner for Patents  
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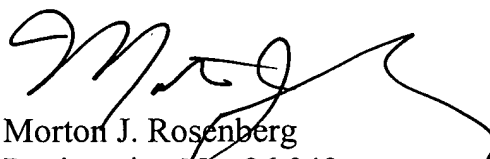
Sir:

The above-referenced patent has issued prior to the publication date and there was no publication of the patent application.

The Publication Fee has previously been paid and a refund of \$300.00 is requested.

The refund of the Publication Fee should be credited to Deposit Account 18-2011.

Respectfully submitted,  
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Dated: 9 Dec. 2004

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